

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade HiCap X7R

6.3 V TO 100 V

I μF to 10 μF RoHS compliant & Halogen Free









Surface-Mount Ceramic Multilayer Capacitors | Automotive grade

 $\times 7R$

6.3 V to 100 V

SCOPE

This specification describes Automotive grade X7R series chip capacitors with lead-free terminations and used for automotive equipments.

<u>APPLICATIONS</u>

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- · AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- · High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

GLOBAL PART NUMBER

AC xxxx x x xxx x B x xxx

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0201 (0603) / 0402 (1005) / 0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225) /1812 (4532)

(2) TOLERANCE

 $| = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales before order

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

(4) TC MATERIAL

X7R

(5) RATED VOLTAGE

 $4 = 4 \ \lor$

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

G = 35 V

9 = 50 V

0 = 100 V

(6) PROCESS

B = X7R

(7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

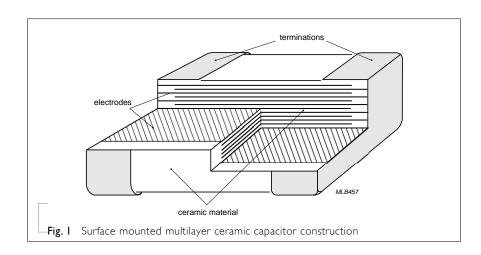
Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

×7R

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

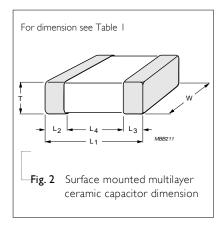


DIMENSION

Table I For outlines see fig. 2

TVDE	1. (mm) \\\ \(mm\) \T (MM)		T (MANA)	L ₂ / L ₃ ((mm)	L ₄ (mm)	
TYPE	L _I (mm)	W (mm)	T (MM)	min.	max.	min.	
0201	0.6 ±0.03	0.3±0.03	0.3±0.03	0.10	0.20	0.20	
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.40	
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40	
	20 10 10	125 1010	0.6 ±0.10				
0805	2.0 ±0.10	1.25 ±0.10	0.85 ±0.10	0.25	0.75	0.70	
	2.0 ±0.20	1.25 ±0.20	±0.20 1.25 ±0.20				
	22 1015	17.1015	0.6 ±0.10				
	3.2 ±0.15	1.6 ±0.15	0.85 ±0.10				
1206			1.15 ± 0.10	0.25	0.75	1.40	
1200	3.2 ±0.30	1.6 ±0.20	1.25 ±0.20	0.25	0.75	1.40	
			1.6 ±0.20				
	3.2 ±0.30	1.6 ±0.30	1.6 ±0.30				
	3.2 ±0.20	2.5 ±0.20	0.85 ±0.10				
	J.Z ±0.Z0	Z,3 ±0,20	1.25 ±0.20				
1210	3.2 ±0.30	2.5 ±0.20	1.6 ±0.20	0.25	0.75	1.40	
	J.Z ±0.30	2.5 ±0.20	2.0 ±0.20				
	3.2 ±0.40	2.5 ±0.30	2.5 ±0.20				
1808	4.5 ±0.40	2.0 ±0.30	1.25 ±0.20	0.25	0.75	2.20	
			0.85 ±0.10				
1812	4.5 ± 0.40	3.2 ± 0.30	1.25 ±0.20	0.25	0.75		
			1.6 ±0.20				

OUTLINES





Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×7R | 6.3 V to 100 V

CAPACITANCE RANGE & THICKNESS FOR X7R

Г	lable 2	Sizes fron	n 0603 to 0	805							
(CAP.	0603				0805					
_		6.3V	10V	16 V	25 V	6.3 V	10 V	16 V	25 V	35 V	50 V
	ΙμF	0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.1		1.25±0.2	1.25±0.2	1.25±0.2		1.25±0.2
	2.2 uF						1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
	4.7 uF						1.25±0.2	1.25±0.2			
	10 uF					1.25±0.2					

-	Table 3	Sizes 120)6				
(CAP.	1206					
_		6.3 V	10V	16V	25V	50 V	100 V
	ΙμF		1.15±0.10	1.15±0.10	1.60±0.2	1.60±0.2	1.60±0.2
	2.2 µF			1.60±0.2	1.60±0.2	1.60±0.2	1.60±0.2
	4.7 uF	1.60±0.2	1.60±0.2	1.60±0.2			
	10 uF						

Γ	Table 4	Sizes 12	10 to 1812			
(CAP.	1210			1812	
		25 V	50V	100 V	50V	100V
	ΙμF	1.25±0.20	1.25±0.20	2.0±0.2	1.60±0.2	1.60±0.2
	2.2 µF		2.0±0.2	2.0±0.2		
	4.7 µF	2.5±0.2	2.5±0.2			

NOTE

- I. Values in shaded cells indicate thickness class in $\ensuremath{\mathsf{mm}}$
- 2. Capacitance value of non E-6 series is on request

THICKNESS CLASSES AND PACKING QUANTITY

Table 5

YAGEO

Table 3	TI II GIVA 1755	DA CICI	10 0005	QUANTITY PER REEL				
SIZE CODE	THICKNESS	PACKI	NG CODE	TAPE WIDTH	Ø180 MM	/7 INCH	Ø330 MM	13 INCH
	CLASSIFICATION	7 INCH	13 INCH		Paper	Blister	Paper	Blister
0201	0.3 ±0.03 mm	R	Р	8 mm	15,000		50,000	
0402	0.5 ±0.05 mm	R	Р	8 mm	10,000		50,000	
0603	0.8 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
0805	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
1206	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
1200	1.0/1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.85 ±0.1 mm	K	F	8 mm		4,000		10,000
	1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
1210	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	2.0 ±0.2 mm	K		8 mm		2,000		
	2.5 ±0.2 mm	K		8 mm		1,000		
	0.6 / 0.85±0.1 mm	K		I2 mm		2,000		
1812	1.15±0.1 mm	K		I2 mm		1,000		
1012	1.25±0.2 mm	K		I2 mm		1,000		
	1.6 ±0.2 mm	K		I2 mm		2,000		



PAPER/PE TAPE SPECIFICATION

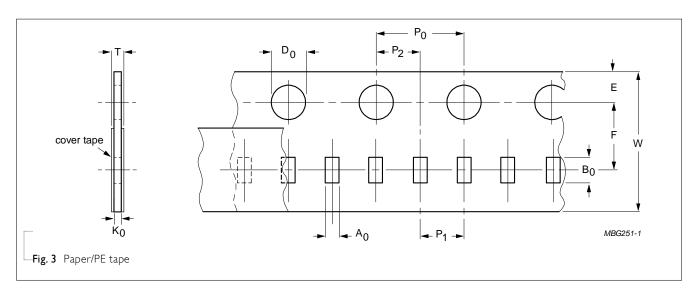


Table 6 Dimensions of paper/PE tape for relevant chip size; see Fig.3

SIZE	SYMBOL Unit: mr										Unit: mm
CODE	A_0	B ₀	W	E	F	P ₀ (I)	P _I	P ₂	ØD ₀	K ₀	Т
0201	0.39 ± 0.06	0.70 ± 0.06	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.55 ± 0.03	0.38 ± 0.05	(0.47 / 0.55)±0.10
0402	0.70 ± 0.15	1.21 ± 0.12	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.50 +0.1 /-0	(0.75 / 0.60)±0.10	(0.85 / 0.70)±0.10
0603	1.05 ± 0.14	1.86 ± 0.13	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
0805	1.50 ± 0.15	2.26 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
1206	1.90 ± 0.15	3.50 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(0.95 / 0.75)±0.10	(1.05 / 0.85)± 0.10

NOTE

1. P_0 pitch tolerance over any 10 pitches is ± 0.2 mm

BLISTER TAPE SPECIFICATION

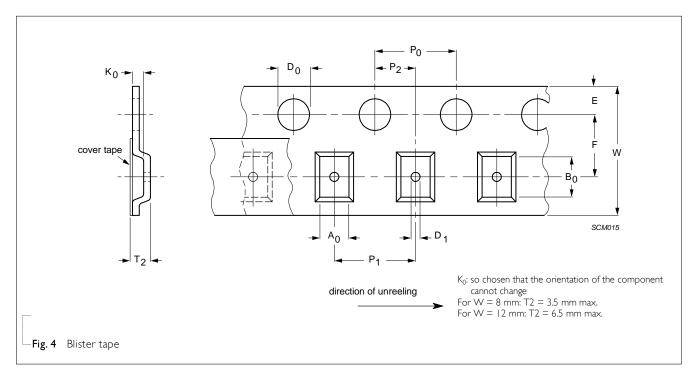


Table 7 Dimensions of blister tape for relevant chip size; see Fig.4

	SYM	SYMBOL Unit: mm											it: mm			
SIZE CODE	A_0		B ₀		K ₀		W	E	F	$ØD_0$	ØD _I	P ₀ (2)	P _I	P ₂	T2	
	Min.	Max.	Min.	Max.	Min.	Max.					Min.				Min.	Max.
0805	1.29	1.65	2.09	2.60	1.25	1.62	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.30	1.67
1206	1.65	2.12	3.30	3.75	1,22	2.15	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1,27	2.20
1210	2.55	3.02	3.31	3.88	0.97	2.92	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	+0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.02	2.97
1808	2.05	2.55	4.80	5.45	1.30	2.45	12.1 ±0.20	1.75 ±0.1	5.5 ±0.05	1.5 +0.1/-0.0	1.5 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1,35	2.50
1812	3.35	3.75	4.70	5.33	0.70	2.40	12.1 ±0.20	1.75 ±0.1	5.5 ±0.05	1.5 +0.1/-0.0	1.5 +0.1/-0.0	4.0 ±0.10	8.0 ±0.10	2.0 ±0.05	0.75	2.45

NOTE

- 1. Typical capacitor displacement in pocket
- 2. P_0 pitch tolerance over any 10 pitches is ± 0.2 mm



REEL SPECIFICATION

YAGEO

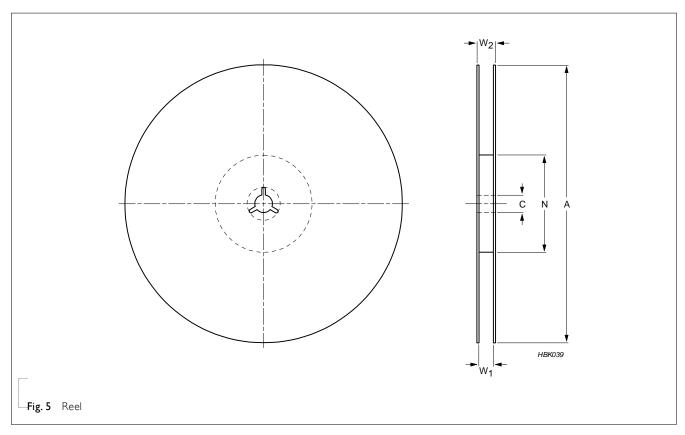


 Table 8
 Reel dimensions; see Fig.5

TARE VAURTU	SYMBOL						
TAPE WIDTH	A	N	С	Wı	W _{2max} .		
8 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	9.4 ±1.5	14.4		
8 (Ø330 mm/13")	330 ±1.0	100 ±1.0	13 +0.50/-0.20	9.0 ±0.2	14.4		
12 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	13.4 ±1.5	18.4		

PROPERTIES OF REEL

Material: polystyrene

Surface resistance: $<10^{10}$ X/sq.



Surface-Mount Ceramic Multilayer Capacitors Automotive grade 6.3 V to 100 V $\times 7R$

ELECTRICAL CHARACTERISTICS

X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

DESCRIPTION Table 9	VALUE
Capacitance tolerance X7R	±5% ⁽¹⁾ , ±10%, ±20%
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):	
X7R	±15%
Operating temperature range: X7R	-55 °C to +125 °C

NOTE

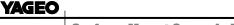
1. Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales force before order

RATED VOLTAGE AND CAPACITANCE

Table 10

CODE	(V)	CAPACITANCE	D.F.	RC @ 25 °C	RC @ 125 °C
	(' /	(µF)		(Ω· F)	(Ω· F)
	6.3	1.0	5.0%	500	50
0603	10	1.0	5.0%	500	50
	16	1.0	5.0%	100	5
	25	1.0	5.0%	100	5
	10	1.0	5.0%	500	50
	16	1.0	5.0%	500	50
	25	1.0	5.0%	500	50
	50	1.0	5.0%	500	10
	10	2.2	5.0%	100	10
0805	16	2.2	5.0%	500	50
_	25	2.2	5.0%	500	50
_	35	2.2	5.0%	500	50
_	10	4.7	10.0%	100	10
_	16	4.7	10.0%	100	10
	6.3	10.0	10.0%	100	10
	10	1.0	3.5%	500	10
	25	1.0	3.5%	500	10
	50	1.0	5.0%	500	10
	100	1.0	5.0%	500	10
_	16	2.2	5.0%	500	50
1206	25	2.2	5.0%	500	50
	50	2.2	5.0%	500	10
	100	2.2	5.0%	500	10
	6.3	4.7	10.0%	50	5
	10	4.7	10.0%	50	5
	16	4.7	10.0%	50	5
	25	1.0	2.5%	500	50
	50	1.0	2.5%	500	50
	100	1.0	5.0%	500	50
1210	50	2.2	5.0%	500	50
	100	2.2	5.0%	500	50
	25	4.7	10.0%	500	10
	50	4.7	10.0%	500	10
1812	50	1.0	2.5%	500	50
1012	100	1.0	2.5%	500	50







 $\times 7$ R

6.3 V to 100 V

SOLDERING RECOMMENDATION

 Tab	le	I	I

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

Table 12 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS No visible damage	
Mounting	IEC 60384- 4.3 21/22		The capacitors may be mounted on printed-circuit boards or ceramic substrates		
Capacitance	IEC 60384- 21/22	4.5.1	At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	Within specified tolerance	
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification on table 10	
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U _r (DC) for I minute	In accordance with specification on table 10	



TEST

Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×7R | 6.3 V to 100 V

PROCEDURE

TEST METHOD

REQUIREMENTS

Temperature coefficient	4.6		Capacitance shall be measured by the steps shown in the $$\Delta$$ C/C: $\pm15\%$ following table.		
			The capacitance change should be measured after 5 min at each specified temperature stage.		
			Step Temperature(°C)		
			a 25±2		
			b Lower temperature±3°C		
			c 25±2		
			d Upper Temperature±2°C		
			e 25±2		
			Class II		
			Capacitance Change shall be calculated from the formula as below		
			$\Delta C = \frac{C2 - C1}{C1} \times 100\%$		
			C1: Capacitance at step c		
			C2: Capacitance at step b or d		
High	AEC-Q200	3	Unpowered; 1000hours @ T=150°C	No visual damage	
Temperature			Measurement at 24±2 hours after test conclusion.	ΔC/C:	
Exposure				±10%	
				D.F.:	
				within initial specified value	
				IR:	
				within initial specified value	
Temperature Cycling	AEC-Q200	4	Preconditioning: 150 +0/–10 °C for I hour, then keep for	No visual damage	
, 3			24 ±1 hours at room temperature	ΔC/C	
				±10%	
			1000 cycles with following detail:		
			30 minutes at lower category temperature 30 minutes at upper category temperature	D.F. meet initial specified value IR meet initial specified value	
			30 minutes at upper category temperature	iix meet imilal specified value	
			Recovery time 24 ±2 hours		
Destructive	AEC-Q200	5	Only applies to SMD ceramics.		
Physical Analysis					



Surface-Mount Ceramic Multilayer Capacitors Automotive grade

 $\times 7R$

6.3 V to 100 V



AEC-Q200

T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.

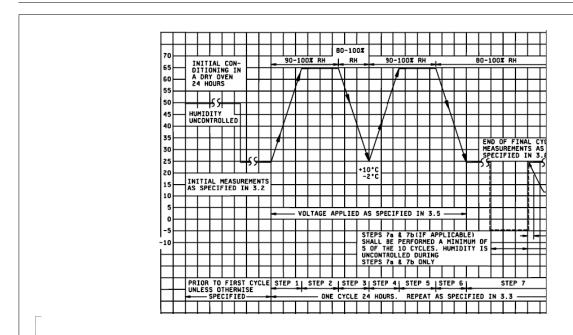
No visual damage

 Δ C/C $\pm 15\%$

D.F.

Within initial specified value

Meet initial specified value



Biased Humidity

Fig. 6 Moisture resistant

AEC-Q200

7

- I. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp
- 2. Initial measure:

Parameter: IR

Measuring voltage: I.5V \pm 0.1 VDC Note: Series with 100 K Ω & 6.8 K Ω

3. Test condition:

85 °C, 85% R.H. connected with 100 K Ω resistor, applied $1.5V/U_r$ for 1,000 hours.

- 4. Recovery: 24 ±2 hours
- 5. Final measure: IR

No visual damage after recovery

Initial requirement:

- Connected to 100 K Ω : $C \le 25 \text{ nF: I.R} \ge 4,000 \text{ M}\Omega \text{ or}$ $C > 25 \text{ nF: (I.R-100 K}\Omega) \times C$ ≥ 100s.

Final measurement:

The insulation resistance shall be greater than 10% of initial spec.





Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×7R | 6.3 V to 100 V

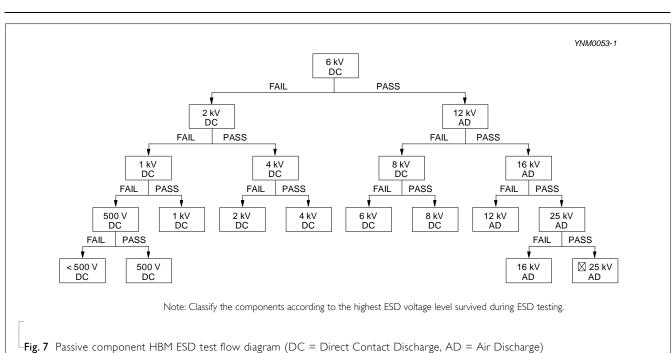
Operational Life	AEC-Q200	8	1. Preconditioning.: 150 +0/-10 °C /1 hour, then keep for	No visual damage
			24 ±1 hour at room temp	ΔC/C ±15%
			2. Initial measure: Spec: refer to initial spec C, D, IR	
				D.F.
			3. Endurance test:	Less than 200% of initial spec.
			Temperature: X7R: 125 °C	IR
			Specified stress voltage applied for 1,000 hours: Applied 150% $\rm U_r$	The insulation resistance shall
			4. Recovery time: 24 ±2 hours	be greater than 10% of initial spec
			5. Final measure: C, D, IR	spec
			Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.	
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification
Mechanical	AEC-Q200	13	Three shocks in each direction shall be applied along the three	ΔC/C
Shock			mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's	±10%
			Duration: 0.5 ms	D.F.
			Velocity change: 15.4 ft/s	Within initial specified value
			Waveform: Half-sin	IR
				Within initial specified value
Vibration	AEC-Q200	00 14	5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8" × 5" PCB. 0.31" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.	ΔC/C
				±10%
				D.F: meet initial specified value
				IR meet initial specified value

YAGEO

Surface-Mount Ceramic Multilayer Capacitors | Automotive grade

6.3 V to 100 V

Resistance to Soldering Heat	AEC-Q200	15	Precondition: $150 \pm 0/-10$ °C for I hour, then keep for 24 ± 1 hours at room temperature Preheating: for size ≤ 1206 : 120 °C to 150 °C for I minute Preheating: for size > 1206 : 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute Solder bath temperature: 260 ± 5 °C Dipping time: 10 ± 0.5 seconds Recovery time: 24 ± 2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
				$\Delta C/C$ $\pm 10\%$ D.F. within initial specified value IR within initial specified value
Thermal Shock	AEC-Q200	16	 Preconditioning.: 150 +0/-10 °C /I hour, then keep for 24 ± I hour at room temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: X7R: -55 °C to +125 °C; 300 cycles I5 minutes at lower category temperature; I5 minutes at upper category temperature. Recovery time: X7R: 24 ±2 hours Final measure: C, D, IR 	No visual damage \[\Delta C/C \\ 15\% \] D.F: meet initial specified value IR meet initial specified value
ESD	AEC-Q200	17	Per AEC-Q200-002	A component passes a voltage level if all components stressed at that voltage level pass.



YAGEO

Surface-Mount Ceramic Multilayer Capacitors Automotive grade

 $\times 7R$

6.3 V to 100 V

Solderability

AEC-Q200

18

Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.

95% of the critical area of each

Test conditions for lead containing solder alloy

Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: I

Test conditions for lead-free containing solder alloy

Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: I

The solder should cover over termination.

Electrical Characterization

AEC-Q200

19

21

Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures.

 Δ C/C

±15%

X7R: -55 $^{\circ}$ C to +125 $^{\circ}$ C Normal temperature: 20 °C

Board Flex

AEC-Q200

Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 \pm 0.2 mm thick and has a layer-thickness 35 μ m \pm 10

Part should be mounted using the following soldering reflow profile.

Conditions:

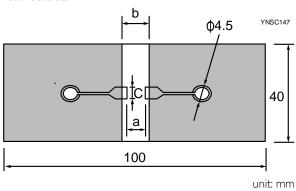
Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm

No visible damage

 Δ C/C

±10%

Test Substrate:



	Dimension(mm)		
Туре	а	b	С
0201	0.3	0.9	0.3
0402	0.4	1.5	0.5
0603	1.0	3.0	1.2
0805	1.2	4.0	1.65
1206	2.2	5.0	1.65
1210	2.2	5.0	2.0
1808	3.5	7.0	3.7





Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×7R | 6.3 V to 100 V

Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before, during and after the test, the device shall comply with all electrical requirements stated in this specification.
Beam Load Test AEC-Q200 23		23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	\leq 0805 Thickness > 0.5mm: 20N Thickness \leq 0.5mm: 8N \geq 1206 Thickness \geq 1.25 mm: 54N Thickness \leq 1.25 mm: 15N
Voltage Proof			 Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur Charge/Discharge current is less than 50 mA 	No breakdown or flashover



Product specification 18

Surface-Mount Ceramic Multilayer Capacitors | Automotive grade

6.3 V to 100 V

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Feb. 25, 2021	-	- New

[&]quot;YAGEO reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."



Surface-Mount Ceramic Multilayer Capacitors | Automotive grade

x7R

6.3 V to 100 V

LEGAL DISCLAIMER

YAGEO, its distributors and agents (collectively, "YAGEO"), hereby disclaims any and all liabilities for any errors, inaccuracies or incompleteness contained in any product related information, including but not limited to product specifications, datasheets, pictures and/or graphics. YAGEO may make changes, modifications and/or improvements to product related information at any time and without notice.

YAGEO makes no representation, warranty, and/or guarantee about the fitness of its products for any particular purpose or the continuing production of any of its products. To the maximum extent permitted by law, YAGEO disclaims (i) any and all liability arising out of the application or use of any YAGEO product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for a particular purpose, non-infringement and merchantability.

YAGEO statements regarding the suitability of products for certain types of applications are based on YAGEO's knowledge of typical operating conditions for such types of applications in a generic nature. Such statements are neither binding statements of YAGEO nor intended to constitute any warranty concerning the suitability for a specific customer application or use. They are intended for use only by customers with requisite knowledge and experience for determining whether YAGEO products are the correct products for their application or use. In addition, unpredicatable and isolated cases of product failure may still occur, therefore, customer application or use of YAGEO products which requires higher degree of reliability or safety, shall employ additional protective safeguard measures to ensure that product failure would not result in personal injury or property damage.

YAGEO products are not designed for application or use in medical, life-saving, or life-sustaining devices or for any other application or use in which the failure of YAGEO products could result in personal injury or death. Customers using or selling YAGEO products not expressly indicated for above-mentioned purposes shall do so at their own risk and agree to fully indemnify YAGEO and hold YAGEO harmless.

Information provided here is intended to indicate product specifications only. YAGEO reserves all the rights for revising this content without further notification, as long as products are unchanged. Any product change will be announced by PCN.

